

## SENSITIVE GATE SCR

<b>IPAK (Plastic)</b>	<b>On-State Current</b> 4 Amp	<b>Gate Trigger Current</b> < 200 $\mu$ A
	<b>Off-State Voltage</b> 200 V ÷ 600 V	
	These series of <b>S</b> ilicon <b>C</b> ontrolled <b>R</b> ectifier use a high performance PNPN technology.  These parts are intended for general purpose applications where high gate sensitivity is required like small engine ignition, SMPS crowbar protection, food procesor.	

## Absolute Maximum Ratings, according to IEC publication No. 134

SYMBOL	PARAMETER	CONDITIONS	Min.	Max.	Unit
$I_{T(RMS)}$	On-state Current	180° Conduction Angle, $T_c = 105\text{ }^\circ\text{C}$ $T_a = 25\text{ }^\circ\text{C}$	4 1.35		A
$I_{T(AV)}$	Average On-state Current	Half Cycle, $\theta = 180^\circ$ , $T_c = 105\text{ }^\circ\text{C}$ $T_a = 25\text{ }^\circ\text{C}$	2.5 0.9		A
$I_{TSM}$	Non-repetitive On-State Current	Half Cycle, 60 Hz	33		A
$I_{TSM}$	Non-repetitive On-State Current	Half Cycle, 50 Hz	30		A
$I^2t$	Fusing Current	$t = 10\text{ms}$ , Half Cycle	4.5		$\text{A}^2\text{s}$
$V_{GRM}$	Peak Reverse Gate Voltage	$I_{GR} = 10\text{ }\mu\text{A}$	8		V
$I_{GM}$	Peak Gate Current	20 $\mu\text{s}$ max.		1.2	A
$P_{GM}$	Peak Gate Dissipation	20 $\mu\text{s}$ max.		3	W
$P_{G(AV)}$	Gate Dissipation	20 ms max.		0.2	W
$T_j$	Operating Temperature		-40	+125	$^\circ\text{C}$
$T_{stg}$	Storage Temperature		-40	+150	$^\circ\text{C}$
$T_L$	Lead Temperature for Soldering	10s at 4.5mm from case		260	$^\circ\text{C}$

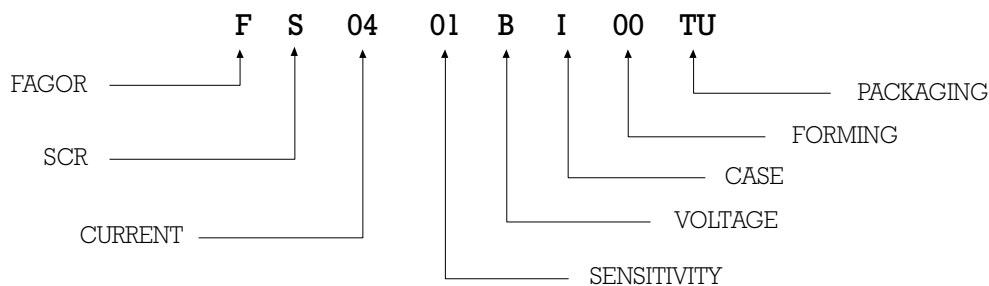
SYMBOL	PARAMETER	CONDITIONS	VOLTAGE			Unit
			B	D	M	
$V_{DRM}$ $V_{RRM}$	Repetitive Peak Off State Voltage	$R_{GK} = 1\text{ K}$	200	400	600	V

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## Electrical Characteristics

SYMBOL	PARAMETER	CONDITIONS	SENSITIVITY				Unit	
			01	04	02	03		
$I_{GT}$	Gate Trigger Current	$V_D = 12 V_{DC}, R_L = 33 \Omega, T_j = 25^\circ C$	MIN	1	15		20	$\mu A$
			MAX	20	50	200	200	
$I_{DRM} / I_{RRM}$	Off-State Leakage Current	$V_D = V_{DRM}, R_{GK} = 220 \Omega, T_j = 125^\circ C$	MAX	1				mA
		$V_R = V_{RRM}, T_j = 25^\circ C$	MAX	5				$\mu A$
$V_{TM}$	On-state Voltage	at $I_T = 8 \text{ Amp}, t_p = 380 \mu s, T_j = 25^\circ C$	MAX	1.6				V
$V_{GT}$	Gate Trigger Voltage	$V_D = 12 V_{DC}, R_L = 33 \Omega, T_j = 25^\circ C$	MAX	0.8				V
$V_{GD}$	Gate Non Trigger Voltage	$V_D = V_{DRM}, R_L = 3.3K \Omega, R_{GK} = 220 \Omega, T_j = 125^\circ C$	MIN	0.1				V
$I_H$	Holding Current	$I_T = 50 \text{ mA}, R_{GK} = 1K \Omega, T_j = 25^\circ C$	MAX	5				mA
$I_L$	Latching Current	$I_G = 1 \text{ mA}, R_{GK} = 1K \Omega, T_j = 25^\circ C$	MAX	6				mA
$dv / dt$	Critical Rate of Voltage Rise	$V_D = 0.67 \times V_{DRM}, R_{GK} = 220 \Omega, T_j = 125^\circ C$	MIN	10	10	5	10	V/ $\mu s$
$di / dt$	Critical Rate of Current Rise	$I_G = 2 \times I_{GT}, Tr = 100 \text{ ns}, F = 60 \text{ Hz}, T_j = 125^\circ C$	MIN	50				A/ $\mu s$
$R_{th(j-c)}$	Thermal Resistance Junction-Case for DC			7.5				$^\circ C/W$
$R_{th(j-a)}$	Thermal Resistance Junction-Ambient			100				$^\circ C/W$

## PART NUMBER INFORMATION



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Fig. 1: Maximum average power dissipation versus average on-state current

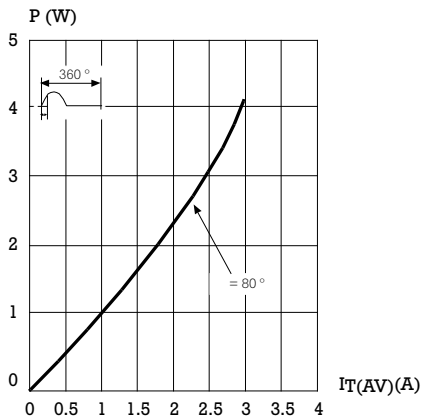


Fig. 3: Average on-state current versus case temperature

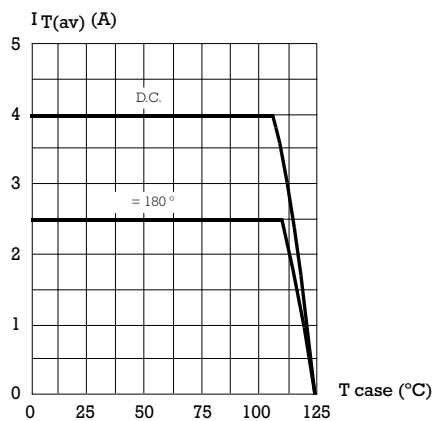


Fig. 5: Relative variation of gate trigger current and holding current versus junction temperature.

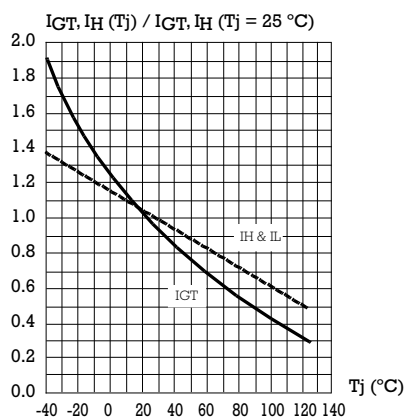


Fig. 2: Correlation between maximum average power dissipation and maximum allowable temperature ( $T_{amb}$  and  $T_{case}$ ).

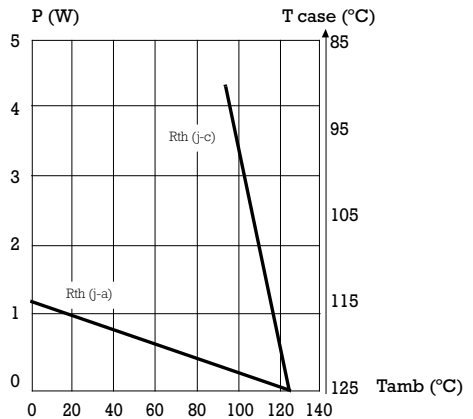


Fig. 4: Relative variation of thermal impedance junction to ambient versus pulse duration.

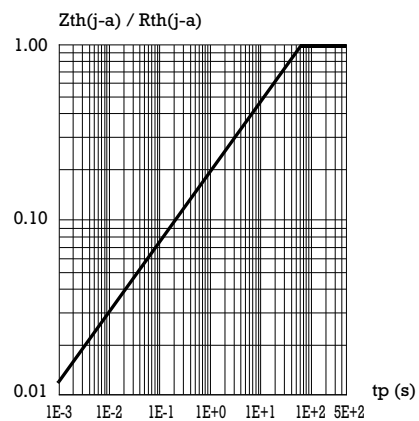
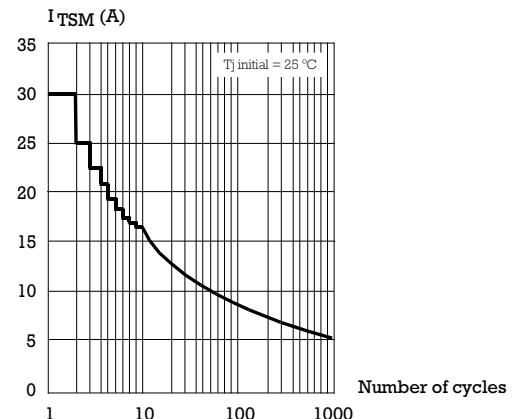


Fig. 6: Non repetitive surge peak on-state current versus number of cycles.



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Fig. 7: Non repetitive surge peak on-state current for a sinusoidal pulse with width:  $t_p = 10$  ms, and corresponding value of  $I^2t$ .

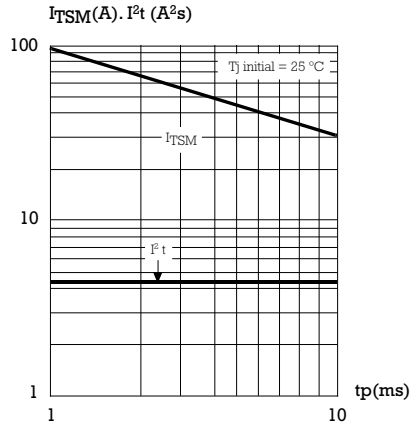
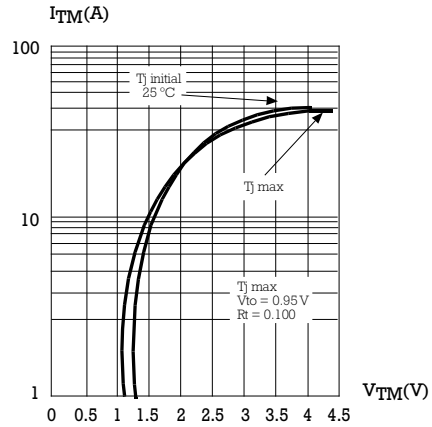


Fig. 8: On-state characteristics (maximum values).



**PACKAGE MECHANICAL DATA** IPAK TO 251-AA

REF.	DIMENSIONS		
	Milimeters		
	Min.	Nominal	Max.
A	2.19	2.3±0.08	2.38
A1	0.89	1.067±0.01	1.14
b	0.64	0.75±0.1	0.89
b1	0.76	0.95	1.14
c	0.46		0.58
c2		0.8±0.013	
D	5.97	6.1±0.1	6.22
D1	5.21		5.52
E	6.35	6.58±0.14	6.73
E1	5.21	5.36±0.1	5.46
e		2.28BSC	
L	8.89	9.2±0.2	9.65
L1	1.91	2±0.1	2.28
L3	0.89		1.27

Marking: type number  
Weight: 0.2 g